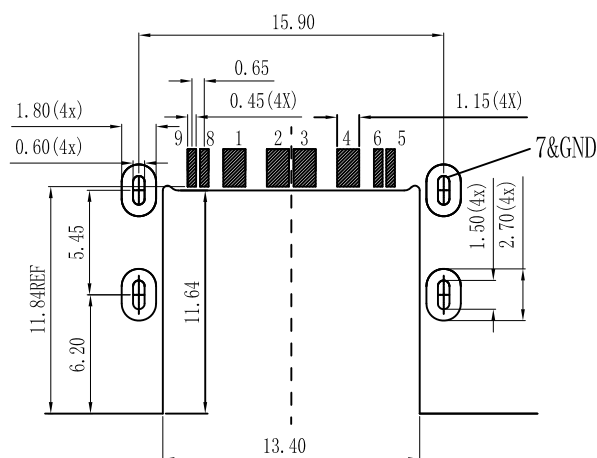
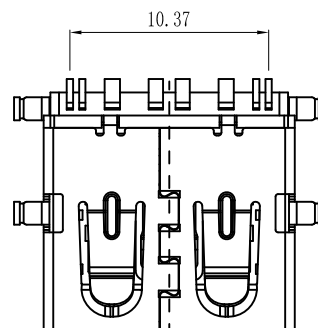
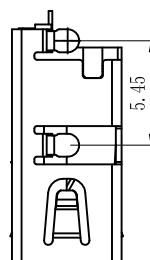
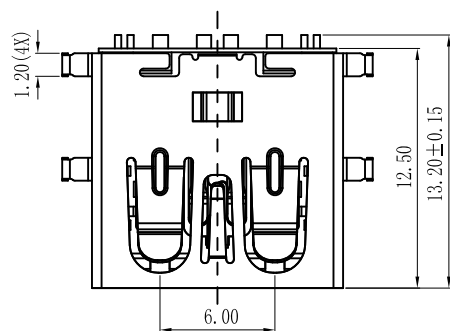
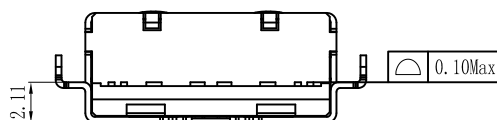
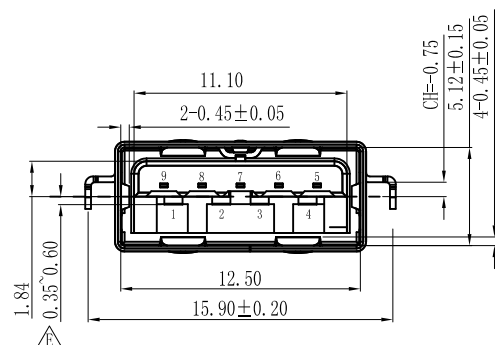




TOLERANCE: ± 0.05 , RECOMMENDED PCB LAYOUT
(TOP VIEW)

Pin NUMBER	SIGNAL NAME
1	VBUS
2	D-
3	D+
4	GND
5	StdA_SSRX-
6	StdA_SSRX+
7	GND_DRAIN
8	StdA_SSTX-
9	StdA_SSTX+
Shel1	Shield

3	SHELL	SUS304-3/4H	50u" Min. NICKEL PLATED OVERALL
2	CONTACT	C5191-EH	Overall nickel plating 50u" ~ 100u", contact area gold plating 1U", welding leg tin plating 100u"
1	HSG	LCP+30%GF	BLACK/BLUE UL94V-0
NO.	PART NAME	MATERIAL	DESCRIPTION

 深圳市华宇创精密电子有限公司			
TOLERANCE: X.X ± 0.30 X.XX ± 0.25 X.XXX ± 0.15 X.* $\pm 2^{\circ}$ X.X* $\pm 0.5^{\circ}$		DRAWN BY : 陈一鸣	
CHECKED BY: 马跃		PART NAME: USB 3.1 AF 10Gbps 沉板 H=2.11mm	
		PART NO. HYCW183-USBA09-211B	
UNIT: mm [inch]		MOLD NO.	
SCALE: 1:1 SIZE: A4		DRAW NO: HYC-2604281533	
APPROVED BY: 邱敏		SHEET NO. 1 OF 1	